

High Isolation X-SP4T (DP8T) SWITCH

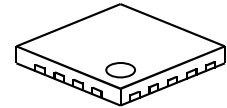
■ GENERAL DESCRIPTION

The NJG1695ME7 is a GaAs X (cross) - SP4T (DP8T) switch MMIC for switching of balanced (differential) mode filters. It features low insertion loss and very high isolation for balanced signal input.

The ESD protection circuits are integrated in the IC to achieve high ESD tolerance.

The ultra-small and ultra-thin EQFN18-E7 package is adopted.

■ PACKAGE OUTLINE



NJG1695ME7

*) The X-SP4T is a paired SP4T switch that features two identical SP4T switches being integrated into one chip. The two SP4T switches are controlled synchronously, and their respective RF lines cross each other on the chip.

■ APPLICATIONS

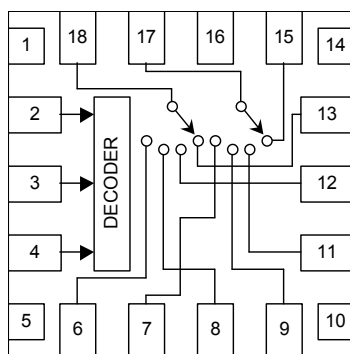
Switching of balanced type filters (Quad band) application
Suitable for 3G and LTE application

■ FEATURES

- Low operation voltage $V_{DD}=+1.5\sim+4.5V$
- Low control voltage $V_{CTL(H)}=+1.35V$ min.
- High isolation
(Balanced mode) 43dB typ. @f=1.0GHz, $P_{IN}=0dBm$
 38dB typ. @f=2.0GHz, $P_{IN}=0dBm$
 35dB typ. @f=2.7GHz, $P_{IN}=0dBm$
- Low insertion loss 0.45dB typ. @f=1.0GHz, $P_{IN}=0dBm$
 0.55dB typ. @f=2.0GHz, $P_{IN}=0dBm$
 0.80dB typ. @f=2.7GHz, $P_{IN}=0dBm$
- Small package EQFN18-E7 (Package size: 2.0mm x 2.0mm x 0.397mm typ.)
- RoHS compliant and Halogen Free
- MSL 1

■ PIN CONFIGURATION

(Top View)



- | | |
|----------|-------------|
| 1. GND | 10. GND |
| 2. VDD | 11. P2B |
| 3. VCTL2 | 12. P2A |
| 4. VCTL1 | 13. P1A |
| 5. GND | 14. GND |
| 6. P4A | 15. P1B |
| 7. P4B | 16. GND(NC) |
| 8. P3A | 17. PCB |
| 9. P3B | 18. PCA |

■ TRUTH TABLE

“H”= $V_{CTL(H)}$, “L”= $V_{CTL(L)}$

| ON PATH | VCTL1 | VCTL2 |
|------------------|-------|-------|
| PCA-P1A, PCB-P1B | H | L |
| PCA-P2A, PCB-P2B | L | L |
| PCA-P3A, PCB-P3B | L | H |
| PCA-P4A, PCB-P4B | H | H |

NOTE: The information on this datasheet is subject to change without notice.

NJG1695ME7

■ ABSOLUTE MAXIMUM RATINGS

($T_a=+25^{\circ}\text{C}$, $Z_s=Z_l=50\Omega$)

| PARAMETERS | SYMBOL | CONDITIONS | RATINGS | UNITS |
|-----------------------|-----------|--|----------|--------------------|
| RF Input Power | P_{IN} | $V_{DD}=2.7\text{V}$, $V_{CTL}=0\text{V}/1.8\text{V}$ ON state port | 28 | dBm |
| Supply Voltage | V_{DD} | VDD terminal | 5.0 | V |
| Control Voltage | V_{CTL} | VCTL terminal | 5.0 | V |
| Power Dissipation | P_D | Four-layer FR4 PCB with through-holes (74.2mmx74.2mm), $T_j=150^{\circ}\text{C}$ | 1400 | mW |
| Operating Temperature | T_{opr} | | -40~+90 | $^{\circ}\text{C}$ |
| Storage Temperature | T_{stg} | | -55~+150 | $^{\circ}\text{C}$ |

■ ELECTRICAL CHARACTERISTICS

(General conditions: $T_a=+25^{\circ}\text{C}$, $Z_s=Z_l=50\Omega$, $V_{DD}=2.7\text{V}$, $V_{CTL(L)}=0\text{V}$, $V_{CTL(H)}=1.8\text{V}$, with application circuit)

| PARAMETERS | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------|--------------|------------|------|-----|------|---------------|
| Supply Voltage | V_{DD} | | 1.5 | 2.7 | 4.5 | V |
| Operating Current | I_{DD} | | - | 30 | 60 | μA |
| Control Voltage (LOW) | $V_{CTL(L)}$ | | 0 | 0 | 0.45 | V |
| Control Voltage (HIGH) | $V_{CTL(H)}$ | | 1.35 | 1.8 | 4.5 | V |
| Control Current | I_{CTL} | | - | 5 | 10 | μA |

■ ELECTRICAL CHARACTERISTICS

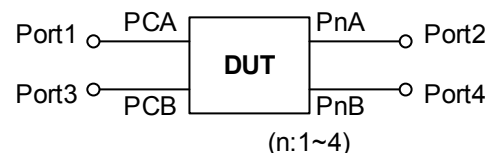
(General conditions: $T_a=+25^{\circ}\text{C}$, $Z_s=Z_l=50\Omega$, $V_{DD}=2.7\text{V}$, $V_{CTL(L)}=0\text{V}$, $V_{CTL(H)}=1.8\text{V}$, with application circuit)

| PARAMETERS | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|---------------------|--|-----|------|------|---------------|
| Insertion Loss 1 | LOSS1 | $f=1.0\text{GHz}$, $P_{IN}=0\text{dBm}$ | - | 0.40 | 0.60 | dB |
| Insertion Loss 2 | LOSS2 | $f=2.0\text{GHz}$, $P_{IN}=0\text{dBm}$ | - | 0.45 | 0.65 | dB |
| Insertion Loss 3 | LOSS3 | $f=2.7\text{GHz}$, $P_{IN}=0\text{dBm}$ | - | 0.80 | 1.0 | dB |
| Balanced mode isolation 1 <small>(Note1)</small> | B-ISL1 | $f=1.0\text{GHz}$, $P_{IN}=0\text{dBm}$ PC-P1, P2, P3, P4 | 40 | 43 | - | dB |
| Balanced mode Isolation 2 <small>(Note1)</small> | B-ISL2 | $f=2.0\text{GHz}$, $P_{IN}=0\text{dBm}$ PC-P1, P2, P3, P4 | 35 | 38 | - | dB |
| Balanced mode isolation 3 <small>(Note1)</small> | B-ISL3 | $f=2.7\text{GHz}$, $P_{IN}=0\text{dBm}$ PC-P1, P2, P3, P4 | 32 | 35 | - | dB |
| Isolation 1 | ISL1 | PCA-P1A, P2A, P3A, P4A PCB-P1B, P2B, P3B, P4B $f=1.0\text{GHz}$, $P_{IN}=0\text{dBm}$ | 26 | 28 | - | dB |
| Isolation 2 | ISL2 | PCA-P1A, P2A, P3A, P4A PCB-P1B, P2B, P3B, P4B $f=2.0\text{GHz}$, $P_{IN}=0\text{dBm}$ | 23 | 26 | - | dB |
| Isolation 3 | ISL3 | PCA-P1A, P2A, P3A, P4A PCB-P1B, P2B, P3B, P4B $f=2.7\text{GHz}$, $P_{IN}=0\text{dBm}$ | 18 | 20 | - | dB |
| Isolation 4 | ISL4 | PCA-PCB port $f=2.0\text{GHz}$, $P_{IN}=0\text{dBm}$ | 17 | 19 | - | dB |
| Input power at 0.2dB Compression Point | $P_{-0.2\text{dB}}$ | $f=2.0\text{GHz}$ | 20 | 23 | - | dBm |
| VSWR | VSWR | $f=2.0\text{GHz}$, On state port | - | 1.2 | 1.4 | - |
| Switching time | T_{SW} | 50% V_{CTL} to 10/90% RF | - | 2 | 5 | μs |

Note1:

The calculation of "Balanced Mode Isolation" uses the following formula.

$$B - ISL = \frac{1}{2}(S_{21} - S_{23} - S_{41} + S_{43})$$

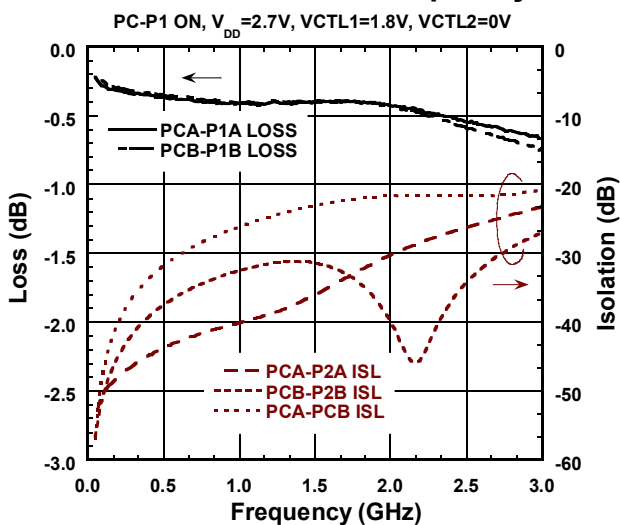


■ TERMINAL INFORMATION

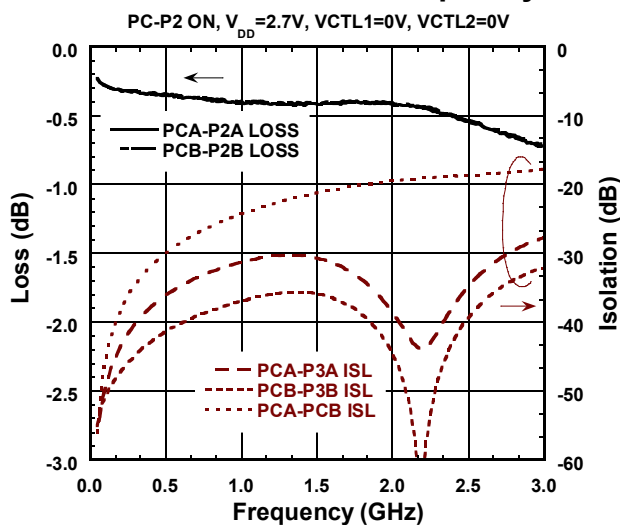
| No. | SYMBOL | DESCRIPTION |
|-----------------|---------|---|
| 1, 5, 10, 14 | GND | Ground terminal. Please connect to the PCB ground plane. |
| 2 | VDD | Positive voltage supply terminal (+1.5~+4.5V). Please place a bypass capacitor between this terminal and GND for best RF performance. |
| 3 | VCTL2 | Control signal input terminal. This terminal is to be set to High-Level (+1.35V~4.5V) or Low-Level (0~+0.45V). |
| 4 | VCTL1 | Control signal input terminal. This terminal is to be set to High-Level (+1.35V~4.5V) or Low-Level (0~+0.45V). |
| 6 | P4A | The 4th RF port of the 1st switch. This port is connected with PCA port. PCB port is connected with P4B port at the same time. An external capacitor is required to block DC voltage. |
| 7 | P4B | The 4th RF port of the 2nd switch. This port is connected with PCB port. PCA port is connected with P4A port at the same time. An external capacitor is required to block DC voltage. |
| 8 | P3A | The 3rd RF port of the 1st switch. This port is connected with PCA port. PCB port is connected with P3B port at the same time. An external capacitor is required to block DC voltage. |
| 9 | P3B | The 3rd RF port of the 2nd switch. This port is connected with PCB port. PCA port is connected with P3A port at the same time. An external capacitor is required to block DC voltage. |
| 11 | P2B | The 2nd RF port of the 2nd switch. This port is connected with PCB port. PCA port is connected with P2A port at the same time. An external capacitor is required to block DC voltage. |
| 12 | P2A | The 2nd RF port of the 1st switch. This port is connected with PCA port. PCB port is connected with P2B port at the same time. An external capacitor is required to block DC voltage. |
| 13 | P1A | The 1st RF port of the 1st switch. This port is connected with PCA port. PCB port is connected with P1B port at the same time. An external capacitor is required to block DC voltage. |
| 15 | P1B | The 1st RF port of the 2nd switch. This port is connected with PCB port. PCA port is connected with P1A port at the same time. An external capacitor is required to block DC voltage. |
| 16 | GND(NC) | Not connected terminal. This terminal is not connected with internal circuit. Please connect it to the PCB ground plane. |
| 17 | PCB | Common RF port of the 2nd switch. This port is connected to one RF port of the 2nd switch (P1B~P4B). An external capacitor is required to block DC voltage. |
| 18 | PCA | Common RF port of the 1st switch. This port is connected to one RF port of the 1st switch (P1A~P4A). An external capacitor is required to block DC voltage. |

■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

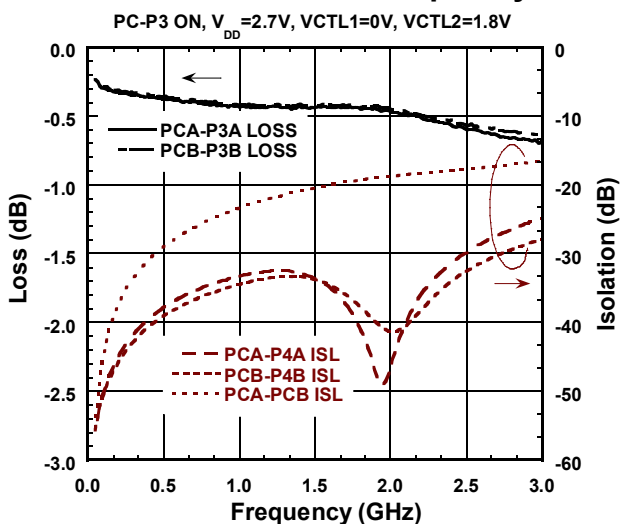
Insertion Loss vs. Frequency



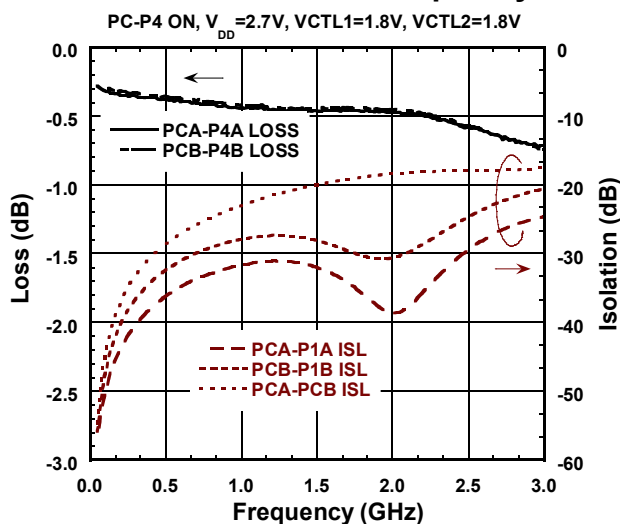
Insertion Loss vs. Frequency



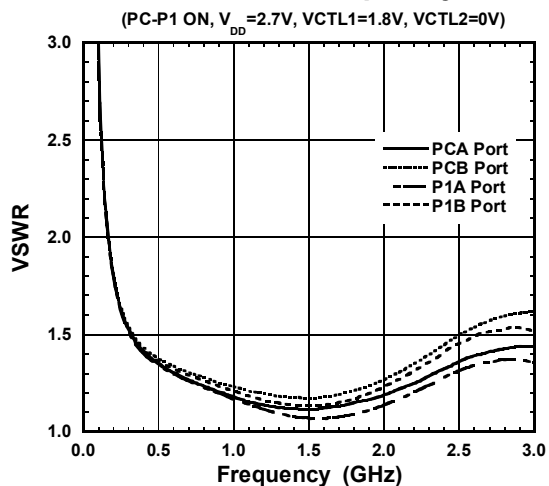
Insertion Loss vs. Frequency



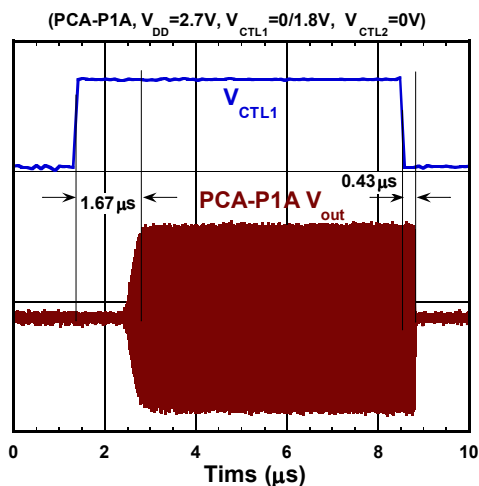
Insertion Loss vs. Frequency



VSWR vs. Frequency



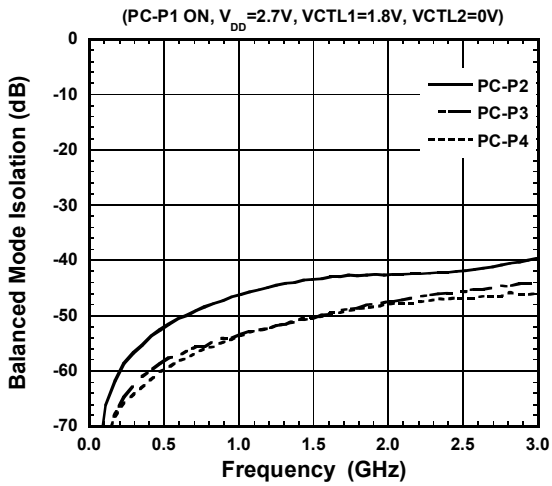
Switching Time



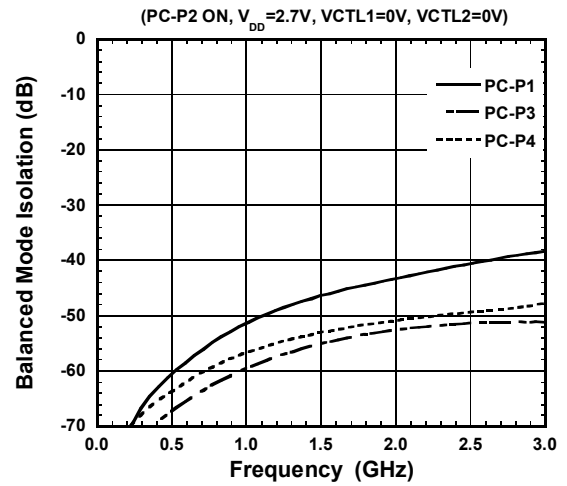
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■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

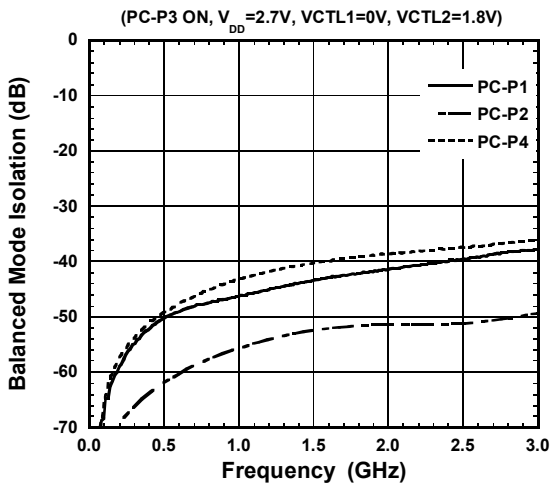
Balanced Mode Isolation vs. Frequency



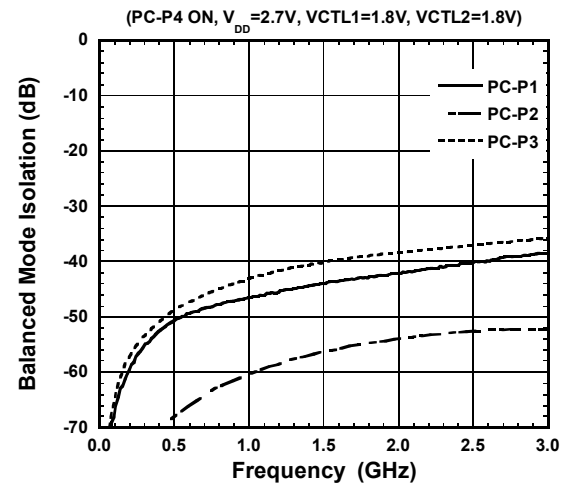
Balanced Mode Isolation vs. Frequency



Balanced Mode Isolation vs. Frequency



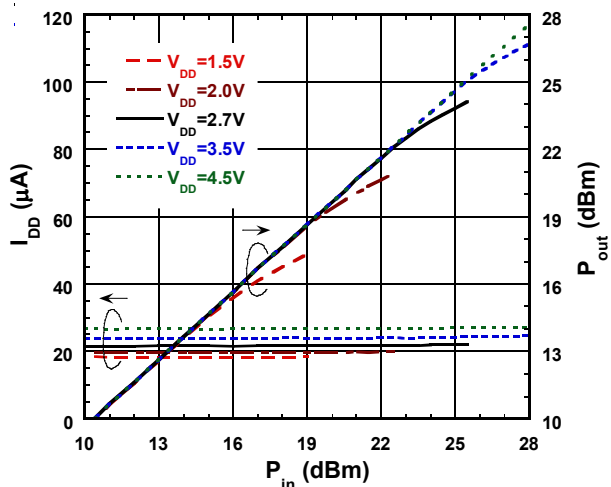
Balanced Mode Isolation vs. Frequency



■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

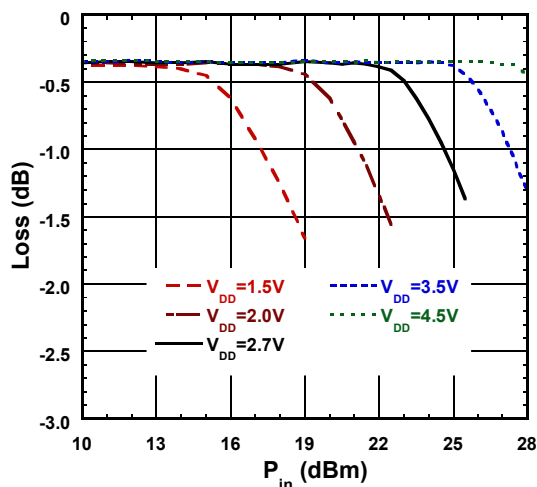
P_{out} & I_{DD} vs. P_{in} at 1.0GHz

(PCB-P1B ON, VCTL1=1.8V, VCTL2=0V)



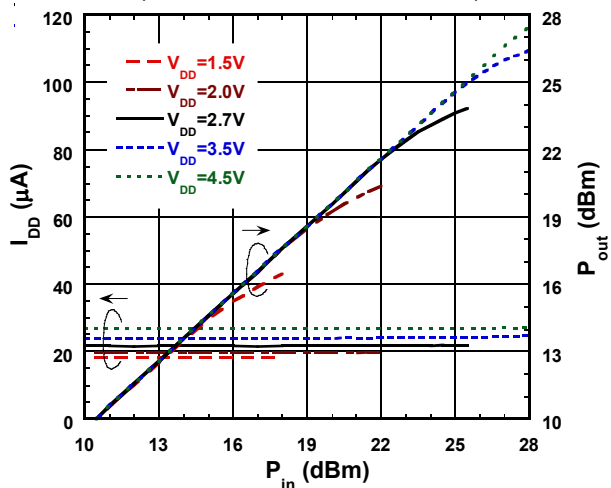
Loss vs. P_{in} at 1.0GHz

(PCB-P1B ON, VCTL1=1.8V, VCTL2=0V)



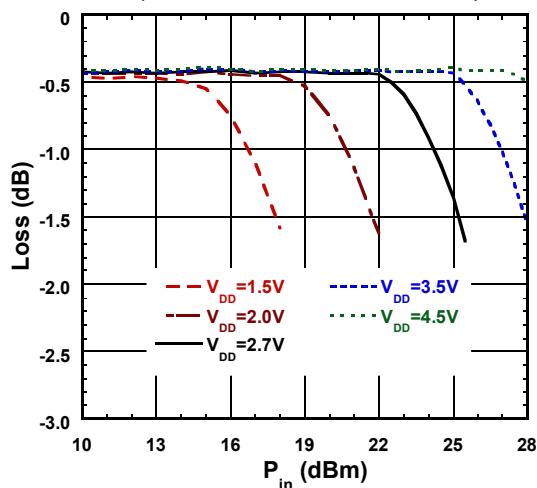
P_{out} & I_{DD} vs. P_{in} at 2.0GHz

(PCB-P1B ON, VCTL1=1.8V, VCTL2=0V)



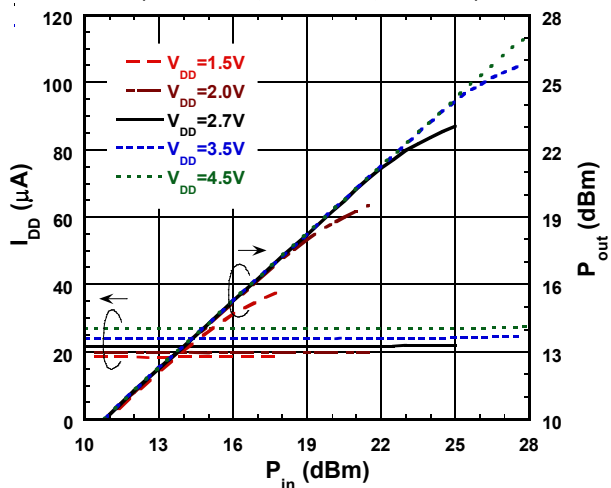
Loss vs. P_{in} at 2.0GHz

(PCB-P1B ON, VCTL1=1.8V, VCTL2=0V)



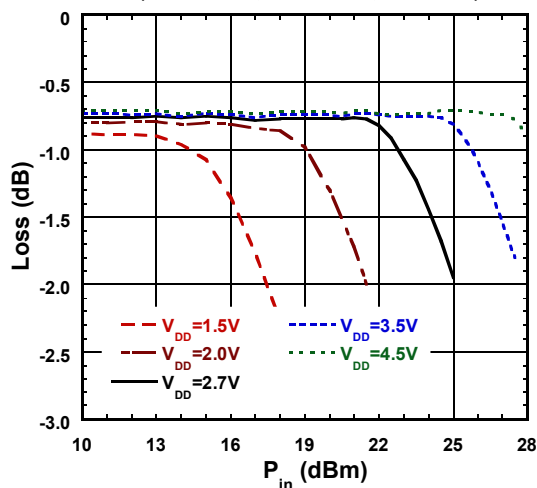
P_{out} & I_{DD} vs. P_{in} at 2.7GHz

(PCB-P1B ON, VCTL1=1.8V, VCTL2=0V)



Loss vs. P_{in} at 2.7GHz

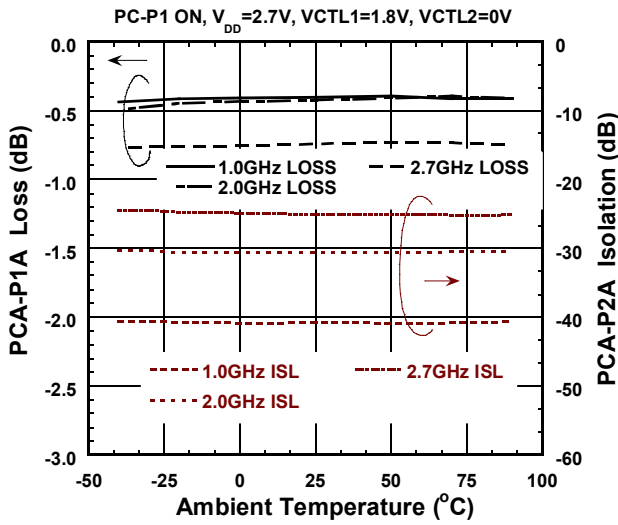
(PCB-P1B ON, VCTL1=1.8V, VCTL2=0V)



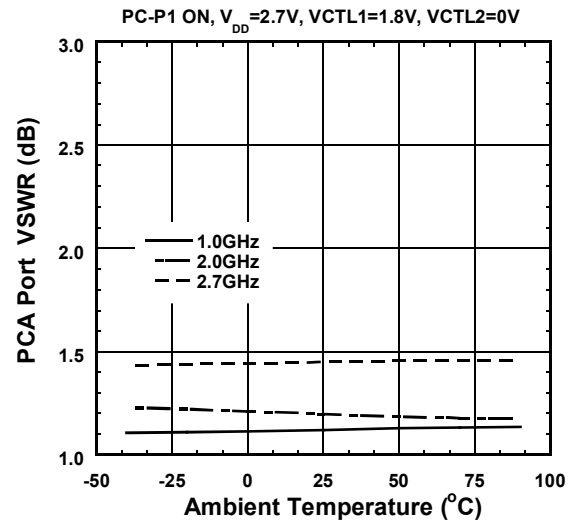
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■ ELECTRICAL CHARACTERISTICS (With Application circuit, Loss of external circuit are excluded)

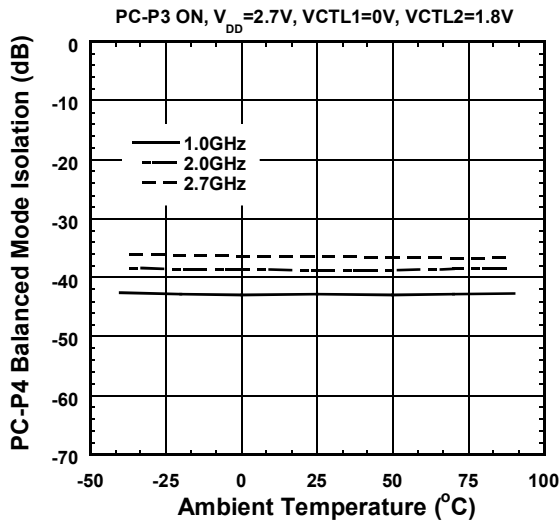
Insertion Loss vs. Temperature



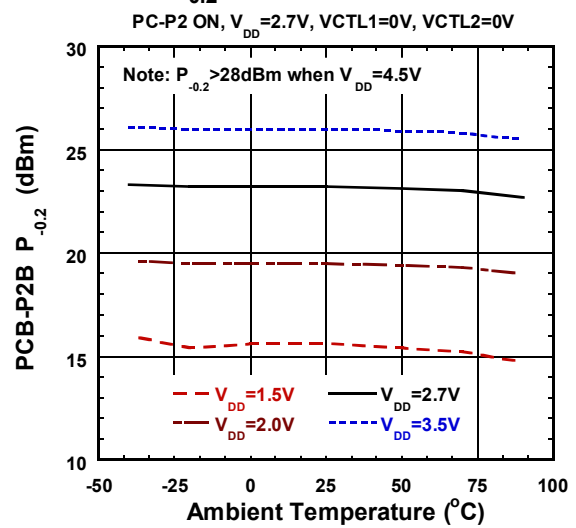
VSWR vs. Temperature



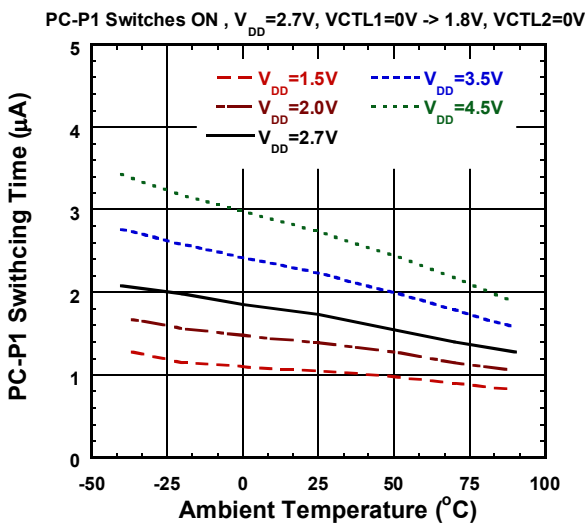
Balanced Mode Isolation vs. Temperature



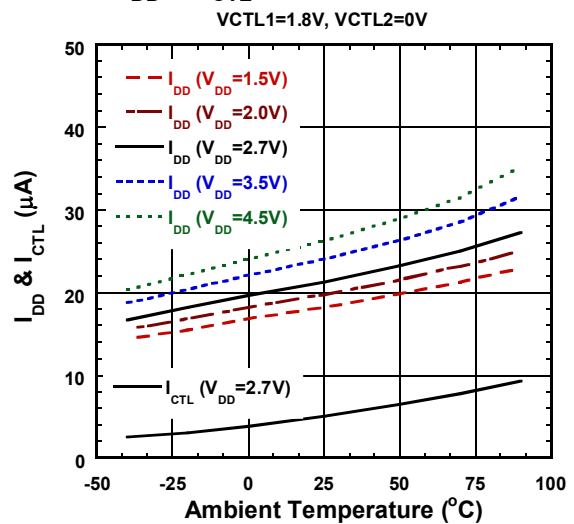
P_{-0.2} vs. Temperature



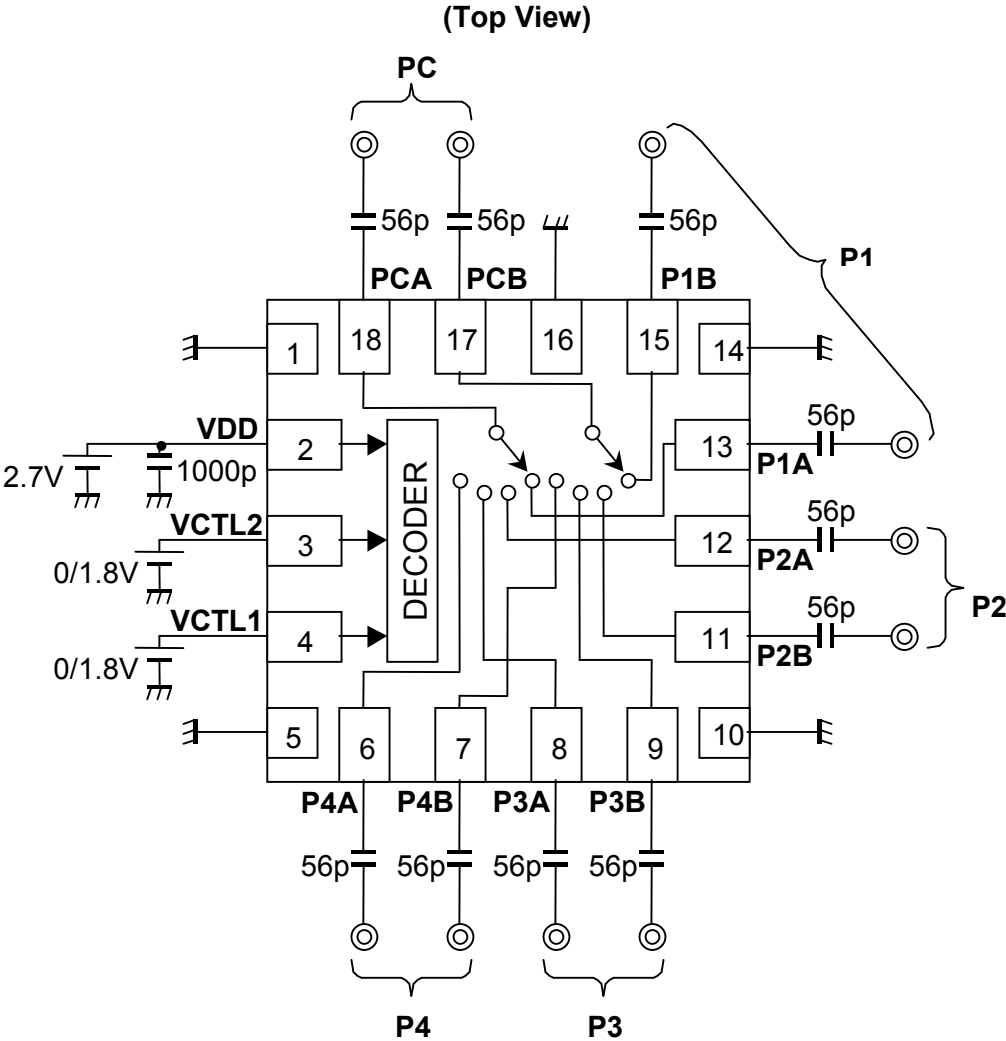
Switching Time vs. Temperature



I_{DD} & I_{CTL} vs. Temperature



■ APPLICATION CIRCUIT

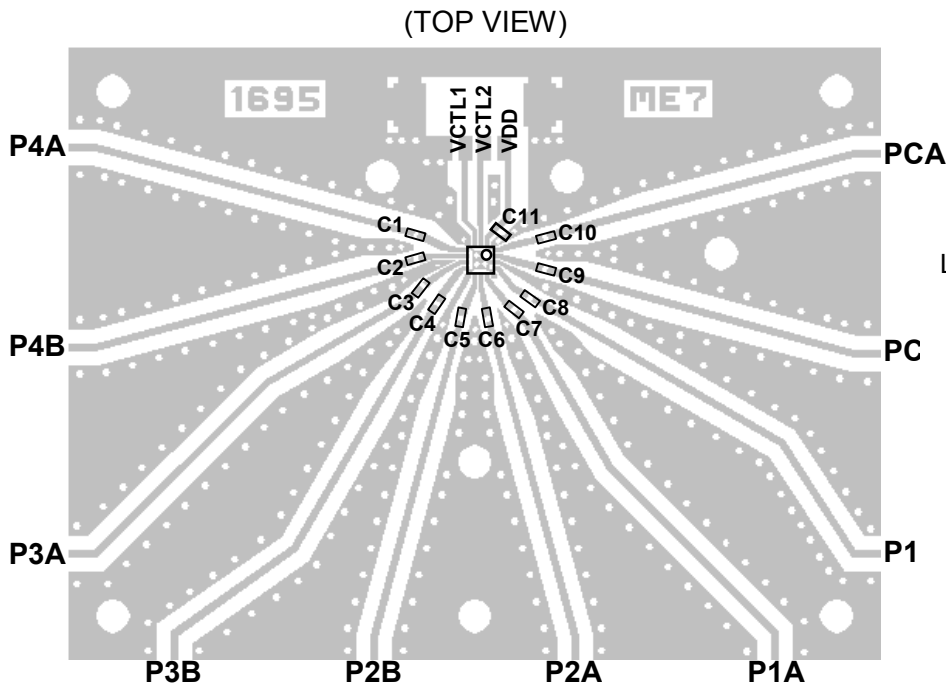


■ PARTS LIST

| Part ID | Value | Notes |
|---------|--------|----------------|
| C1~C10 | 56pF | MURATA (GRM03) |
| C11 | 1000pF | MURATA (GRM15) |

NJG1695ME7

TEST PCB LAYOUT

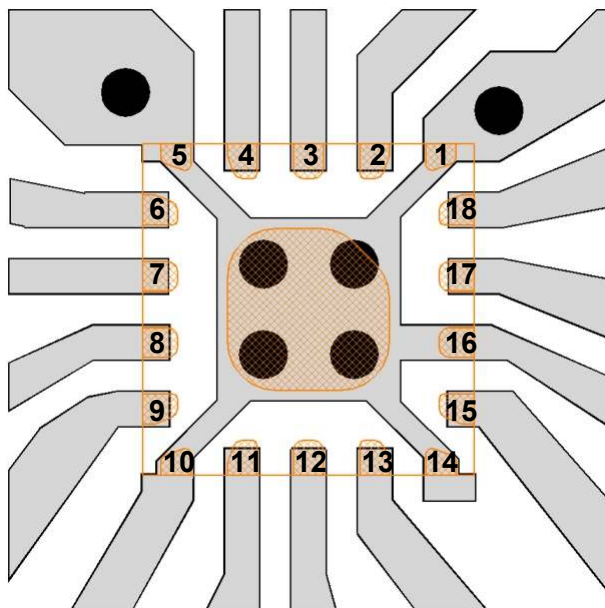


PCB: FR-4, t=0.2mm
 Capacitor Size: 0603, 1005
 Strip Line Width: 0.4mm
 PCB Size: 53 x 40mm

Losses of PCB, capacitors and connectors

| Paths | Frequency (GHz) | Loss (dB) |
|------------------------------------|-----------------|-----------|
| PCA-P1A, PCB-P1B, PCA-P3A, PCB-P3B | 1.0 | 0.50 |
| | 2.0 | 0.84 |
| | 2.7 | 1.10 |
| PCA-P2A, PCB-P2B, PCA-P4A, PCB-P4B | 1.0 | 0.46 |
| | 2.0 | 0.77 |
| | 2.7 | 0.97 |

<PCB LAYOUT GUIDELINE>



- PCB Pattern
- Through-hole (radius: 0.15mm)
- Pin




Note2:

The ground plane and the through-holes under Tab, as shown in the picture, are not necessities. There is no problem in deleting them in the practical PCB design, though in such case beware that the GND terminals (pin 10 and 14 as for this particular design shown in the picture) still need through-holes being located in their vicinities.

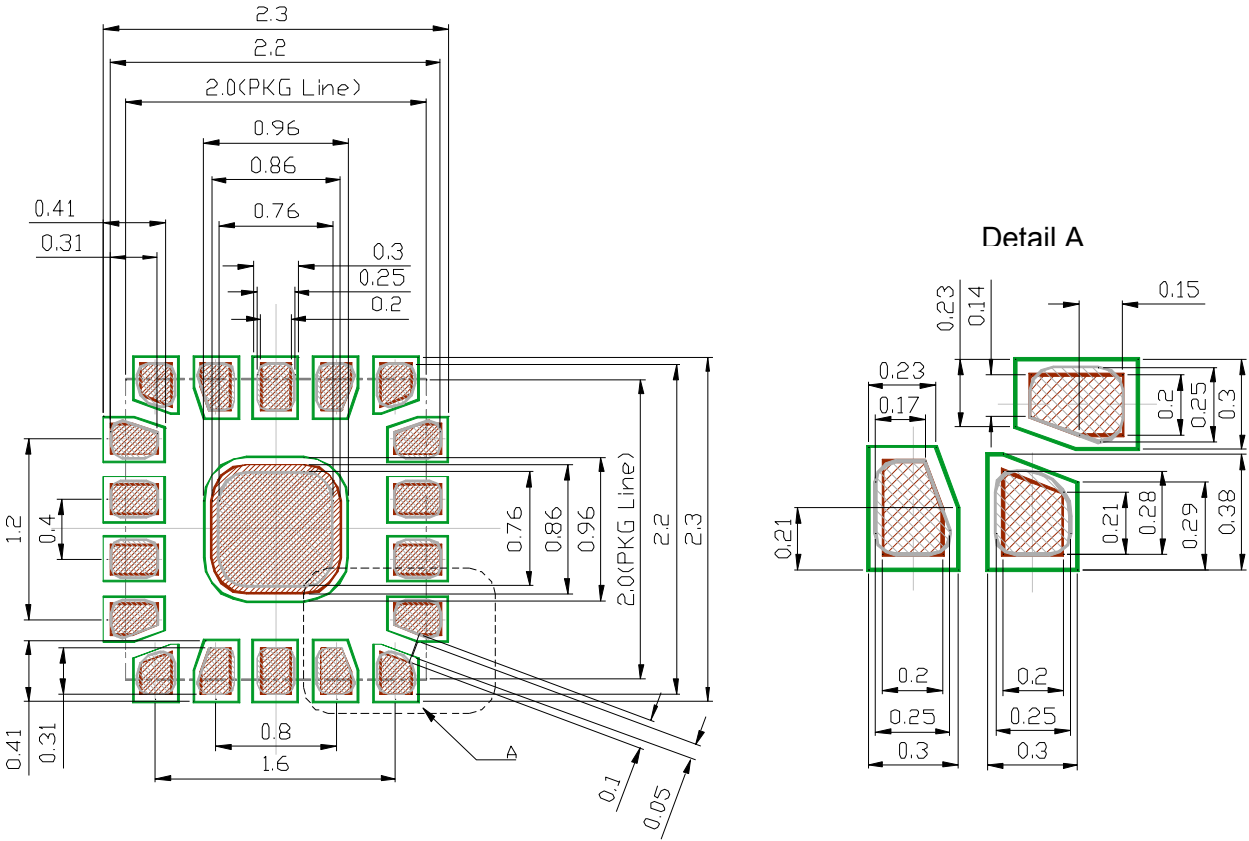
PRECAUTIONS

- [1] The DC current at RF ports must be equal to zero, which can be achieved with DC blocking capacitors (C1~C10).
 (However, in case there is no possibility that DC current flows, the DC blocking capacitors are unnecessary, i.e. the RF signals are fed by SAW filters that block DC current by nature, etc.)
- [2] To reduce stripline influence on RF characteristics, please locate the bypass capacitor (C11) close to VDD terminal.
- [3] For good isolation, the GND terminals must be connected to the PCB ground plane of substrate, and the through-holes connecting the backside ground plane should be placed near by the pin connection.

RECOMMENDED FOOTPRINT PATTERN (EQFN18-E7 PACKAGE REFERENCE)

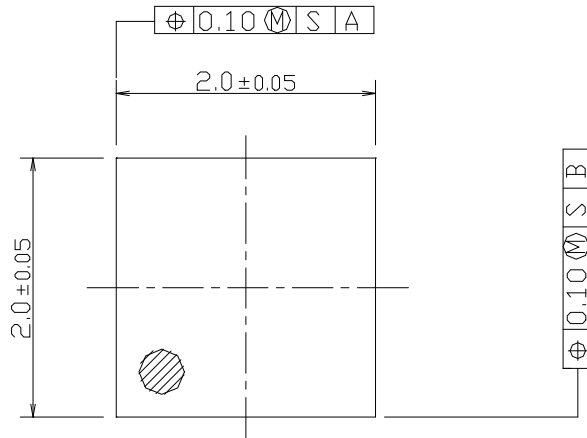
-  : Land
-  : Mask (Open area) *Metal mask thickness: 100um
-  : Resist (Open area)

PKG : 2.0mm x 2.0mm



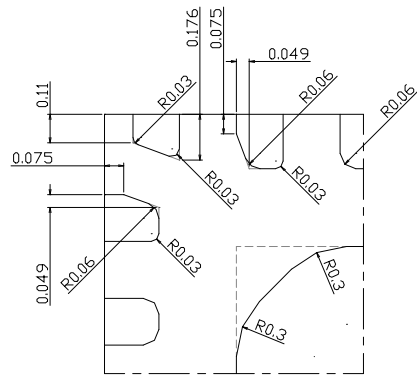
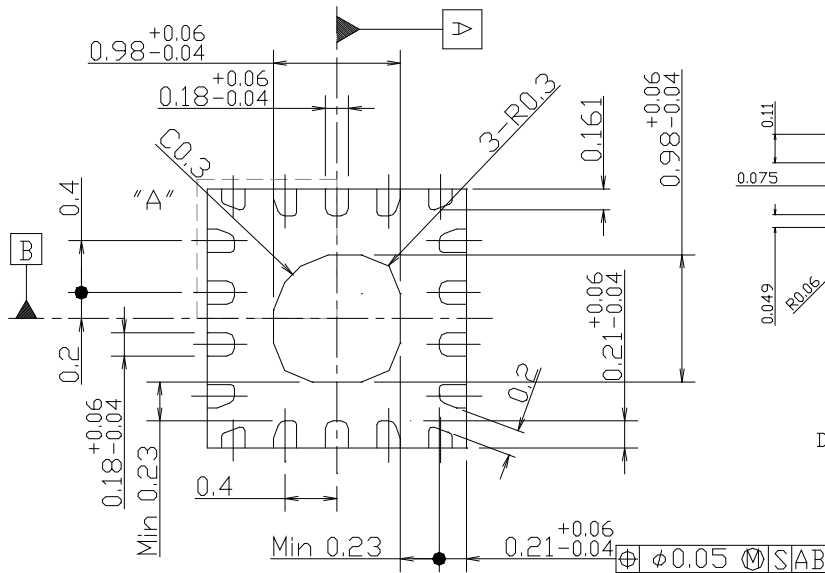
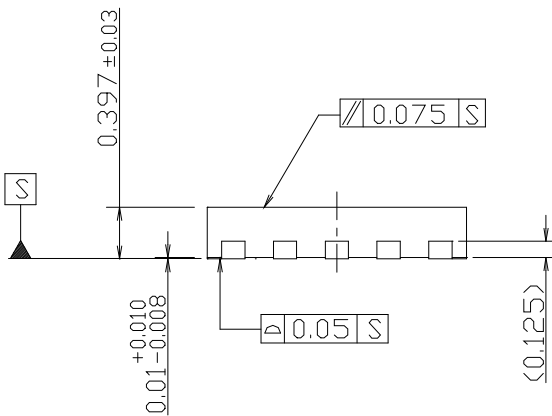
NJG1695ME7

PACKAGE OUTLINE (EQFN18-E7)



Terminal Treat : SnBi
 Board : Copper
 Molding Material : Epoxy resin
 Weight : 5.0mg

Unit : mm



Details of "A" part (x2)

Cautions on using this product

- This product contains Gallium-Arsenide (GaAs) which is a harmful material.
- Do NOT eat or put into mouth.
- Do NOT dispose in fire or break up this product.
- Do NOT chemically make gas or powder with this product.
- To waste this product, please obey the relating law of your country.

[CAUTION]

The specifications on this databook are only given for information, without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.

This product may be damaged with electric static discharge (ESD) or spike voltage. Please handle with care to avoid these damages.

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- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
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- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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